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This listing of claims will replace all prior versions, and listings, of claims in the application:

## Listing of Claims:

- 1 1. (currently amended): A magnetic head comprising:
- 2 a write head portion including a first magnetic pole and a second magnetic pole;
- an induction coil being disposed at least in part between said first and second magnetic
- 4 poles;
- 5 an electrical lead of said induction coil having an electrical lead thickness and being
- 6 disposed in a layer of the magnetic head;
- 7 a heat sink being disposed within said layer and being coplanar within the magnetic head
- 8 with said electrical lead of said coil, said heat sink having a heat sink thickness that is equal to
- 9 said electrical lead thickness, and wherein said heat sink is disposed directly upon a seed layer
- that is disposed at least in part directly upon said second magnetic pole.
- 1 2. (original): A magnetic head as described in claim 1 wherein said electrical lead is
- 2 comprised of copper and said heat sink is comprised of copper.
- 1 3. (cancelled)
- 1 4. (cancelled)
- 1 5. (currently amended): A magnetic head as described in claim [[4]] 1 wherein said heat
- 2 sink includes a first substantial portion that is disposed above said second magnetic pole, and
- 3 another substantial portion that is disposed away from said second magnetic pole.

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- 1 6. (original): A magnetic head as described in claim 5 wherein said heat sink is disposed
- 2 away from an air bearing surface of the magnetic head.
- 1 7. (previously presented): A magnetic head comprising:
- 2 a write head portion including a first magnetic pole and a second magnetic pole;
- an induction coil being disposed at least in part between said first and second magnetic
- 4 poles;
- 5 an electrical lead of said induction coil being disposed in a layer of the magnetic head;
- a first heat sink being coplanar within the magnetic head with said electrical lead of said
- 7 coil and a second heat sink, and wherein said first heat sink and said second heat sink are
- 8 thermally interconnected by a heat sink interconnect member.
- 1 8. (original): A magnetic head as described in claim 7 wherein said second heat sink is
- 2 disposed below said first magnetic pole.
- 1 9. (previously presented): A magnetic head as described in claim 8 wherein said first heat
- 2 sink is thermally interconnected through an interconnect member with a slider body portion of
- 3 the magnetic head.
- 1 10. (previously presented): A magnetic head as described in claim 8 wherein said first heat
- 2 sink is thermally interconnected with said second heat sink through an interconnect member, and
- 3 said second heat sink is thermally interconnected with said slider body through a second
- 4 interconnect member.

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- 1 11. (original): A magnetic head as described in claim 1 wherein said magnetic head is a
- 2 longitudinal head.
- 1 12. (original): A magnetic head as described in claim 1 wherein said magnetic head is a
- 2 perpendicular magnetic head.
- 1 13-20 (cancelled):
- 1 21. (currently amended): A hard disk drive, comprising:
- at least one hard disk being adapted for rotary motion upon a disk drive;
- 3 at least one slider device having a slider body portion being adapted to fly over said hard
- 4 disk;
- 5 a magnetic head being formed on said slider body for writing data to said hard disk, said
- 6 magnetic head including:
- 7 a write head portion including a first magnetic pole and a second magnetic pole;
- 8 an induction coil being disposed at least in part between said first and second magnetic
- 9 poles;
- an electrical lead of said induction coil having an electrical lead thickness and being
- 11 disposed in a layer of the magnetic head;
- a heat sink being disposed within said layer and being coplanar within the magnetic head
- with said electrical lead of said coil, said heat sink having heat sink thickness that is equal to said
- 14 electrical lead thickness, and wherein said heat sink is disposed directly upon a seed layer that is
- disposed at least in part directly upon said second magnetic pole.

- 1 22. (cancelled)
- 1 23. (cancelled)
- 1 24. (previously presented): A hard disk drive, comprising:
- 2 at least one hard disk being adapted for rotary motion upon a disk drive;
- 3 at least one slider device having a slider body portion being adapted to fly over said hard
- 4 disk;
- a magnetic head being formed on said slider body for writing data to said hard disk, said
- 6 magnetic head including:
- 7 a write head portion including a first magnetic pole and a second magnetic pole;
- 8 an induction coil being disposed at least in part between said first and second magnetic
- 9 poles;
- an electrical lead of said induction coil being disposed in a layer of the magnetic head;
- a first heat sink being coplanar within the magnetic head with said electrical lead of said
- 12 coil and a second heat sink, and wherein said first heat sink and said second heat sink are
- thermally interconnected by a heat sink interconnect member.
- 1 25. (original): A hard disk drive as described in claim 24 wherein said second heat sink is
- 2 disposed below said first magnetic pole.

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- 1 26. (previously presented): A hard disk drive as described in claim 25 wherein said first heat
- 2 sink is thermally interconnected through an interconnect member with a slider body portion of
- 3 the magnetic head.
- 1 27. (previously presented): A hard disk drive as described in claim 25 wherein said first heat
- 2 sink is thermally interconnected with said second heat sink through an interconnect member, and
- 3 said second heat sink is thermally interconnected with said slider body through a second
- 4 interconnect member.